

# 2SD882

## NPN MEDIUM POWER TRANSISTOR

### Features

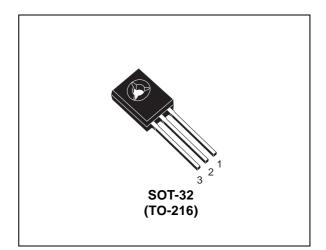
- HIGH CURRENT
- LOW SATURATION VOLTAGE
- COMPLEMENT TO 2SB772

### **Applications**

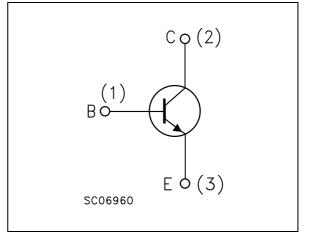
- VOLTAGE REGULATION
- RELAY DRIVER
- GENERIC SWITCH
- AUDIO POWER AMPLIFIER
- DC-DC CONVERTER

### Description

The device is a NPN transistor manufactured by using planar Technology resulting in rugged high performance devices. The complementary PNP type is 2SB772.



## Internal Schematic Diagram



## **Order Codes**

Part Number	Marking	Package	Packing
2SD882	D882	SOT-32	TUBE

# 1 Absolute Maximum Ratings

Symbol	Parameter	Value	
V <sub>CBO</sub>	Collector-Base Voltage (I <sub>E</sub> = 0)	60	V
V <sub>CEO</sub>	Collector-Emitter Voltage (I <sub>B</sub> = 0)	30	V
$V_{EBO}$	Collector-Base Voltage ( $I_C = 0$ )	5	V
Ι <sub>C</sub>	Collector Current	3	Α
I <sub>CM</sub>	Collector Peak Current (t <sub>P</sub> < 5ms)	6	Α
Ι <sub>Β</sub>	Base Current	1	Α
I <sub>BM</sub>	Base Peak Current (t <sub>P</sub> < 5ms)	2	Α
P <sub>TOT</sub>	Total dissipation at $T_c = 25^{\circ}C$	12.5	W
T <sub>STG</sub>	Storage Temperature	-65 to 150	°C
ТJ	Max. Operating Junction Temperature	150	°C

#### Table 1. Absolute Maximum Rating

#### Table 2. Thermal Data

Symbol	Parameter	Value	Unit
R <sub>thJ-case</sub>	Thermal Resistance Junction-Case Max	10	°C/W

V

V

V

V

V

V

MHz

0.4

0.7

1.1

1.2

300

60

5

100

80

30

100

I<sub>B</sub> = 50 mA

I<sub>B</sub> = 100 mA

I<sub>B</sub> = 150 mA

I<sub>B</sub> = 100 mA

 $V_{CE} = 2 V$ 

 $V_{CE} = 2 V$ 

 $V_{CE} = 2 V$ 

 $V_{CE} = 10 V$ 

## 2 Electrical Characteristics

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
I <sub>CES</sub>	Collector Cut-off Current (V <sub>BE</sub> = 0)	V <sub>CE</sub> = 60 V			10	μA
I <sub>CEO</sub>	Collector Cut-off Current $(I_B = 0)$	V <sub>CE</sub> = 30 V			100	μA
	Emitter Cut-off Current (I <sub>C</sub> = 0)	V <sub>EB</sub> = 5 V			10	μA
Moto: 1	Collector-Emitter Breakdown Voltage ( $I_B = 0$ )	I <sub>C</sub> = 10 mA	30			V

I<sub>C</sub> = 100 μA

I<sub>E</sub> = 100 μA

I<sub>C</sub> = 1 A

 $I_{C} = 2 A$ 

 $I_{\rm C} = 3 \, {\rm A}$ 

I<sub>C</sub> = 2 A

 $I_C = 1 A$ 

 $I_{\rm C} = 3 \text{ A}$  $I_{\rm C} = 0.1 \text{ A}$ 

I<sub>C</sub> = 100 mA

#### Table 3. Electrical Characteristics (T<sub>CASE</sub> = 25°C; unless otherwise specified)

Note: 1 Pulsed duration =  $300 \ \mu s$ , duty cycle  $\le 1.5\%$ .

Collector-Base Breakdown

Emitter-Base Breakdown Voltage

Collector-Emitter Saturation

Base-Emitter Saturation Voltage

Voltage

 $(I_{E} = 0)$ 

 $(I_{C} = 0)$ 

Voltage

DC Current Gain

Transition Frequency

V<sub>(BR)CBO</sub>

V<sub>(BR)EBO</sub>

V<sub>CE(sat)</sub>

Note: 1

V<sub>BE(sat)</sub>

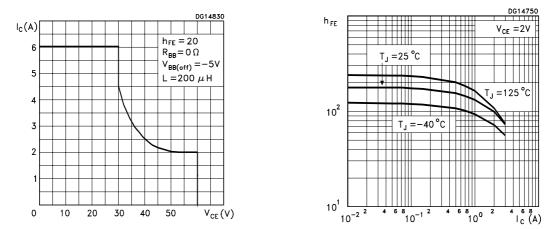
Note: 1

hFE

fΤ



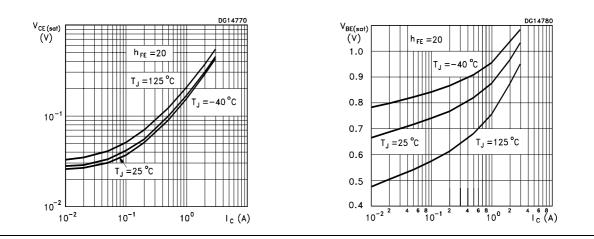
## 2.1 Typical characteristics



#### Figure 1. Reverse biased area

Figure 2. DC current gain







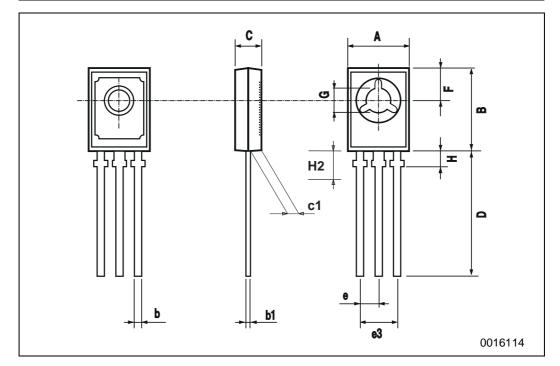
## 3 Package Mechanical Data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com



DIM.		mm		inch			
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
А	7.4		7.8	0.291		0.307	
В	10.5		10.8	0.413		0.445	
b	0.7		0.9	0.028		0.035	
b1	0.49		0.75	0.019		0.030	
С	2.4		2.7	0.040		0.106	
c1	1.0		1.3	0.039		0.050	
D	15.4		16.0	0.606		0.629	
е		2.2			0.087		
e3	4.15		4.65	0.163		0.183	
F		3.8			0.150		
G	3		3.2	0.118		0.126	
Н			2.54			0.100	









# 4 Revision History

Date	Revision	Changes
09-Sep-2005	2	Final datasheet. New template



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